

### 3.0x2.0mm SMD CHIP LED LAMP

APK3020SURC-F01

HYPER RED

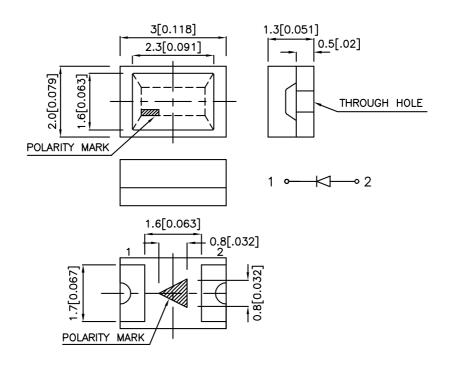
### **Features**

- •3.0mmX2.0mm SMT LED, 1.3mm THICKNESS.
- •LOW POWER CONSUMPTION.
- •WIDE VIEWING ANGLE.
- •IDEAL FOR BACKLIGHT AND INDICATOR.
- •VARIOUS COLORS AND LENS TYPES AVAILABLE.
- •PACKAGE: 2000PCS/REEL.
- RoHS COMPLIANT.

### **Description**

The Hyper Red source color devices are made with DH InGaAIP on GaAs substrate Light Emitting Diode.

### **Package Dimensions**



### Notes

- All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.2(0.008")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

 SPEC NO: DSAF1361
 REV NO: V.1
 DATE: MAR/29/2005
 PAGE: 1 OF 4

 APPROVED: J. Lu
 CHECKED: Allen Liu
 DRAWN: S.H.CHEN
 ERP:1204000143-01

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### **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) @ 20mA		Viewing Angle
			Min.	Тур.	201/2
APK3020SURC-F01	HYPER RED (InGaAIP)	WATER CLEAR	70	230	120°

Note:

### Electrical / Optical Characteristics at T<sub>A</sub>=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	640		nm	IF=20mA
λD	Dominant Wavelength	Hyper Red	628		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	27		nm	IF=20mA
С	Capacitance	Hyper Red	45		pF	VF=0V;f=1MHz
VF	Forward Voltage	Hyper Red	1.9	2.5	V	IF=20mA
İR	Reverse Current	Hyper Red		10	uA	VR = 5V

### Absolute Maximum Ratings at Ta=25°C

Parameter	Hyper Red	Units	
Power dissipation	170	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	185	mA	
Reverse Voltage	5	V	
Operating/Storage Temperature	-40°C To +85°C		

Note

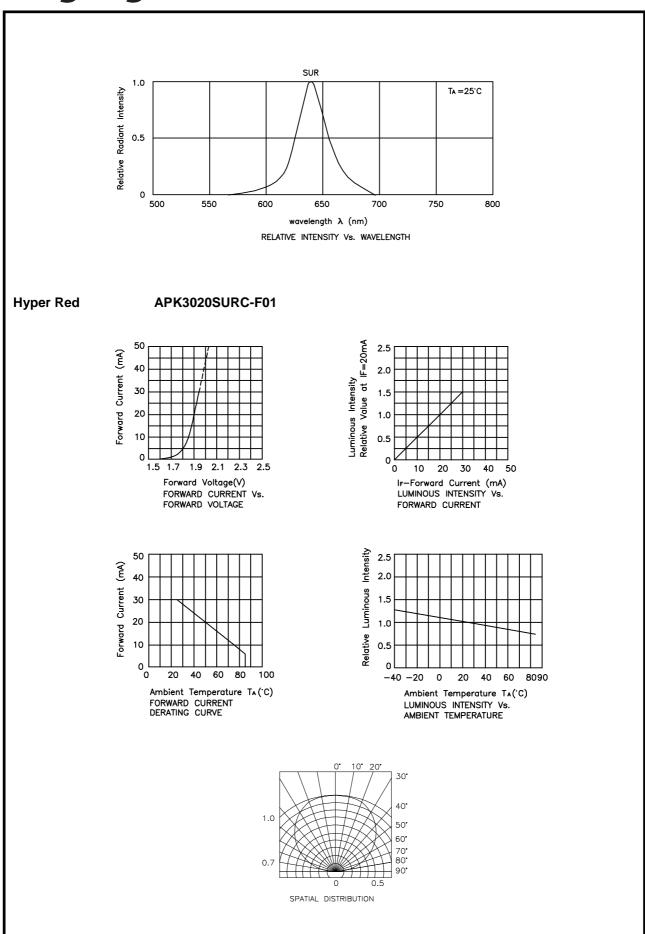
 SPEC NO: DSAF1361
 REV NO: V.1
 DATE: MAR/29/2005
 PAGE: 2 OF 4

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<sup>1.</sup>  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

<sup>1. 1/10</sup> Duty Cycle, 0.1ms Pulse Width.

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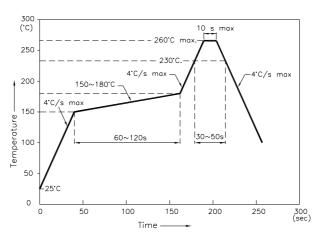
 SPEC NO: DSAF1361
 REV NO: V.1
 DATE: MAR/29/2005
 PAGE: 3 OF 4

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### APK3020SURC-F01

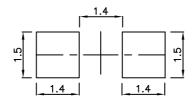
Reflow Soldering Profile For Lead-free SMT Process.



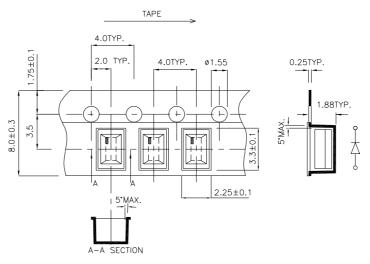
#### NOTES:

- 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

## Recommended Soldering Pattern (Units: mm)



## Tape Specifications (Units: mm)



### Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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